## **CONTENTS**

SR.	TITLE	PAGE
NO.		NO.
	CHAPTER – I	1 TO 12
	INTRODUCTION AND BASIC PRINCIPLE	
1.1	INTRODUCTION	1-2
1.2	SOME DEFINITION AND BASIC PRINCIPLE IN	2 – 8
	ELCTROPLATING	
1.3	CONTROLLING FACTORS IN ELECTROPLATING OF	8 – 11
	METALS	
1.4	AIM AND SCOPE OF PRESENT WORK	11 – 12
	CHAPTER – II	13 TO 21
	EXPERIMENTAL	
2.1	EXPERIMENTAL SET-UP	13
2.2	PREPARATION OF BATH SOLUTION	13
2.3	ANODE AND CATHODE MATERIAL	13
2.4	CLEANING OF THE BASE METAL	13 – 14
2.5	COPPER COULOMETER	14 – 15
2.6	MEASUREMENT OF pH	15
2.7	ELECTRODEPOSITION-WORKING PROCESS	15 – 16
2.8	MEASUREMENT OF OVER VOLTAGE	17 – 18
2.9	ADHESION TEST	19
2.10	TERNISH AND CORROSION RESISTANCE TEST	19
2.11	MEASUREMENT OF THROWING POWER	20 – 21

	CHAPTER – III	22 TO 40
	ELECTRODEPOSITION OF NICKEL	
3.1	INTRODUCTION AND REVIEW OF THE EARLIER	22 – 23
	WORK	
3.2	ELECTRODEPOSITION OF NICKEL FROM	23
	AMMONICAL ACETATE BATH	
3.3	A PROBABLE MECHANISM OF	23 – 24
	ELECTRODEPOSITION OF NICKEL FROM AMMONICAL	
	ACETATE BATH	
3.4	INFLUENCE OF VARIOUS CONTROLLING	25 – 40
	PARAMETER ON CCE & CHARACTER OF THE DEPOSIT	
	CHAPTER – IV KINETIC OF ELECTRODE PROCESSES DURING ELECTRODEPOSITION OF NICKEL	41 TO 71
4.1	INTRODUCTION	41 – 43
4.2	ELECTRODE KINETIES DURING ELECTRODEPOSION	43 – 70
	OF NICKEL FROM AMMONICAL ACETATE BATH	
4.3	CONCLUDING REMARKS ON ELECTRO DEPOSITION OF	70 – 71
	NICKEL AND CATHODIC POLARISATION	
	SUMMARY	72 – 74
	REFERENCES	75 – 79